

Modular Coil Manufacturing Facility- Schedule Week of May 1st.

Day	Date	Coil	Description	Shift	Personnel
Saturday	29-Apr-06	GEN	Cladding & Chill Plates	1st.	R. Tucker, S. Vinson, R. Jakober
		C3	Reposition bundle		M. Hause [Lead]; M. Karlik
Monday	01-May-06	C4	Install Kapton edging/mold release	1st.	R. Tucker; D. Moser
		C2	Solder C2 Joints		M. Hause, M. Dimattia, D. Voorhees
		C3	Reposition bundle		E. Gilsenan, J. Benchoff
		C3	Reposition bundle	2nd.	M. Karlik, S. Vinson
		C2	Solder C2 Joints		M. Anderson [Lead]; R. Jakober, F. Terlitz
Tuesday	02-May-06	C2	Install VPI bag/shell		D. Voorhees, D. Moser, J. Benchoff
		C3	Measure		M. Hause, E. Gilsenan
		GEN	VPI prep		M. Dimattia, R. Tucker
		C3		2nd.	E. Gilsenan [Lead], J. Benchoff
		C2	Install VPI bag/shel		M. Hause [Lead]; D. Voorhees, D. Mose
Wednesday	03-May-06		All hands on 1st. Shift- Attend Electrical UT	1st.	M. Hause; D. Voorhees, M. Karlik, D. Moser, J. Benchoff, S. Vinson, R. Tucker, M. Dimattia, R. Jakober, F. terlitz
		C1	Solder leads		Mike Anderson, T. Meighar
Thursday	04-May-06	C1	Solder C1 Leads	1st.	M. Dimattia & R. Tucker, T. Meighan
		C2	Install VPI bag/shell		M. Hause [Lead]; D. Voorhees
		C3	Complete groundwrap		D. Moser, J. Benchoff
		C2	Complete VPI bag/shell	2nd.	M. Karlik [Lead], S. Vinson
		C3	Complete groundwrap		M. Anderson [lead]; F. Terlitz
Friday	05-May-06	GEN	VPI preparations	1st.	M. Dimattia; R. Tucker
		C2	Install VPI bag/shell		M. Hause [Lead]; D. Voorhees
		C3	Complete groundwrap		D. Moser, J. Benchoff
		C2	Complete VPI bag/shell	2nd.	M. Karlik [Lead], S. Vinson
		C3	Complete groundwrap		M. Anderson [lead]; F. Terlitz
Saturday	06-May-06	GEN	Cladding & Chill Plates	1st.	TBD [3] Techs
		C2	Install VPI bag/shell		M. Hause [Lead], D. Voorhees, J. Benchoff
			No Second Shift		